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> STRESS-INDUCED SHIFTS OF SHALLOW DONOR POLARIZABILITIES IN n-TYPE SILICON*

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Piezocapacitance measurements on high-purity and ntype silicon versus uniaxial stress have yielded strain-dependent donor polarizabilities $\alpha_D(x)$. The valley repopulation model with strain-dependent Bohr radii is inadequate to explain the data. A manyvalley approach featuring strain-dependent valleyvalley coupling is more successful.

I. Introduction

Previous experimental studies have yielded useful information on the strain-dependence of shallow donor wave functions in Si and Ge. These have included measurements of piezoresistance[1], piezohyperfine Fermi contact constants of the donor nucleus[2], and piezohyperfine constants of Si²⁹ nuclei[3] obtained by the ENDOR technique. At liquid He temperatures on the insulating side of the insulatormetal transition the piezoresistance depends on the transfer or hopping matrix between a filled and empty donor site. The donor Fermi contact constant measures $|\psi(\vec{r}=0,x)|^2$ of the donor ground state versus the reduced valley strain x. The ENDOR measurement for a specific Si²⁹ site at \vec{r}_{ℓ} from the donor determines $|\psi(\vec{r}_{\ell},x)|^2$. New piezocapacitance measurements on both high-purity Si and n-type Si samples yield donor polarizabilities $lpha_{\mathrm{D}}(\mathbf{x})$ which give a direct measure of how the size of a donor wave function changes with strain. The experimental results for Si:P cannot be explained with a conventional theory based on the valley repopulation model (VRM) and strain-dependent Bohr radii associated with each valley. A new theoretical approach incorporating different Bohr radii for the strain-admixed $ls-A_1$ and $ls-E_a$ states, rather than with the stress-raised and stresslowered valleys, gives good agreement with the data. However, one must include strain-dependent valley-valley coupling matrix elements.

II. Experiment and Experimental Results

Piezocapacitance measurements, for both [100] and [110] axis uniaxial tensile stresses, have been made on high-purity Si, P-doped and Sb-doped Si samples in the temperature range 4.2K to 1.1K for stresses $\sigma_{\rm S}$ up to 1000 Kgm/cm². The doped samples have donor concentrations (N_D) in the range 6×10^{16} to 1.9×10^{18} /cm³. For all samples the electric field is applied transverse to the stress axis along [001]. The capacitance, after edge corrections, yields the component $\epsilon_{\rm ZZ}(x,N_{\rm D},T)$ of the dielectric tensor. Using the Clausius-Mossotti relationship we obtain an effective donor polarizability component

$$\alpha_{D,zz}(x,N_{D},T) = \frac{3\varepsilon_{h,zz}(x,T)}{4\pi N_{D}} \left[\frac{\varepsilon_{zz}(x,N_{D},T) - \varepsilon_{h,zz}(x,T)}{\varepsilon_{zz}(x,N_{D},T) + 2\varepsilon_{h,zz}(x,T)} \right], \quad (1)$$

where $\varepsilon_{\rm h}$ is the host dielectric constant, and has been found to be ll.40±0.06 as T+OK, in excellent agreement with Faulkner's value (4). The high purity Si data show a linear decrease of $\varepsilon_{\rm ZZ}$ with stress yielding the result $(1/\varepsilon_{\rm h}(0)(\Delta\varepsilon_{\rm h,ZZ}/\Delta\sigma_{\rm S}) = -(3.37\pm0.07)\times10^{-7}\,{\rm cm}^2/{\rm Kgm}$, which is intermediate between values obtained with hydrostatic pressure[5] near room temperature [the uniaxial tension produces a transverse contraction along the electric field].

Figure (1) shows $\alpha_{D,ZZ}(x)$ (we now drop the zz subscript) versus the valley strain x $(x_{100} = \frac{1}{3}(E_{U}/\Delta)(S_{11}-S_{12})\sigma_{S}, x_{110}=\frac{1}{2}x_{100}; E_{U}$ is the shear deformation potential, Δ is the adjacent valley coupling, S_{11} and S_{12} are the elastic compliance constants). For the [100] axis tension F $\alpha_{D}(x)$ decreases, passes through a minimum for $x_{10} \approx 0.6$, and subsequently increases. The hopping contribution to $\alpha_{D}(x,T)$ decreases rapidly with temperature T as T+OK. The $\alpha_{D}(x,T)$ is independent of T. One can extract $\alpha_{D}(x,T+OK)$ from the data. The [110] axis tension data show a decrease with x_{110} that is almost linear, but yields a slight upward deviation from linearity. The slope $(1/\alpha_{D}(0))(\partial\alpha_{D}/\partial x)_{X=0}$ is twice that for the [100] data in agreement with the prediction of the VRM. Other Si:P samples $(N_{D}^{-2}.3 \times 10^{17}/\text{cm}^3)$ show behavior identical to that in Fig.(1) while more concentrated samples $(1.4 \text{ to } 1.9 \times 10^{18}/\text{cm}^3)$ show the same initial slope but with $x_{100}^{+0} \sim 0.4$. A Si:Sb sample $(N_{D} \sim 6 \times 10^{16}/\text{cm}^3)$ exhibits smaller slope at x=0 and gives $x_{100}^{+0} \sim 0.9$.



Fig. 1 $\alpha_{D}(x)$ versus x for Si:P ($N_{D} \sim 5 \times 10^{17} / \text{cm}^{3}$), a)[100], b)[110]

III. Theory of the Strain-Dependent Donor Polarizability

Using the VRM, with valley occupation coefficients $C_1(x)$ for a [100] axis stress of the form $(C_B, C_B, C_A, C_A, C_A, C_A)$ { $C_B(x)$ and $C_A(x)$ given in [2]}, and strain-dependent Bohr radii $a_j(x)$ for the stress-raised and stress-lowered valleys [1] we have shown[6] that

$$\alpha_{\rm D}(\mathbf{x}_{100}) = \mathbf{f}_{\rm u} \alpha_{\perp} + 2C_{\rm A}^2 \left[\mathbf{f}_{\ell}(\alpha_{\parallel} + \alpha_{\perp})\right] , \qquad (2)$$

where $f_u = [a(x_{100})/a(0)]_u^3$ and $f_e = [a(x_{100})/a(0)]_\ell^3$ are factors giving the contribution to $\alpha_D(x_{100})$ from the $a_j(x)$ for the upper and lower valleys respectively. α_{\parallel} and α_{\perp} are the single valley polarizability components parallel and perpendicular to the valley axis. For the

effective mass approximation (EMA) case Dexter[7] found that $\alpha_{\rm EMA} = \frac{1}{3}(\alpha_{\parallel} + 2\alpha_{\perp}) = 4.328 \times 10^5 \text{ Å}^3$, with $\alpha_{\perp}/\alpha_{\parallel} = 2.123$ for $\varepsilon_{\rm h} = 11.4$, $m_{\parallel}/m = 0.9163$, and $m_{\perp}/m = 0.1905$. Using a series expansion and valley coupling parameters for Si:P we obtain[6] $\alpha_{\rm D}(x)/\alpha_{\rm D}(0) = [1-0.0866x+0.0560x^2-0.0072x^3+...]$. This result yields an initial slope at x=0 only 2/3 of the experimental slope and produces a minimum at x~1.3, or more than twice the experimental value for Si:P. Neglecting the strain-dependent Bohr radii ($f_{\rm u}=f_{\ell}=1$) the comparison with the data is even worse. Although the initial slope can be forced equal to the experimental slope by setting $\alpha_{\perp}/\alpha_{\parallel}=3.7$ this pushes the minimum out to x~2 and makes the overall agreement poorer. A strain-dependent $\Delta(x) = \Delta(0)[1+ax+bx^2+cx^3+...]$ can be introduced to force-fit Eq. (2) to the data but the coefficients are large and arbitrary.

$$\psi_{\rm GS}(\dot{r}, x) = \gamma(x)\psi_{\rm Al}(\dot{r}, a_{\rm A}(x)) + \beta(x)\psi_{\rm Ea}(\dot{r}, a_{\rm E}(x)) , \qquad (3)$$

where the c, are $(1/6)^{\frac{1}{2}}(1,1,1,1,1,1)$ for the ls-A₁ state and $(1/12)^{\frac{1}{2}}(-2,-2,1,1,1,1)$ for the ls-E_a state and $\gamma(x)$ and $\beta(x)$ are related to $C_A(x)$ and $C_B(x)$ of the VRM by $\gamma(x)=(2/3)^{\frac{1}{2}}(2C_A+C_B)$ and $\beta(x)=(4/3)^{\frac{1}{2}}(C_A-C_B)$. $a_A(x)$ and $a_E(x)$ are strain-dependent Bohr radii for the ls-A₁ and ls-E_a states. Calculating $\alpha_D(x)$ with the trial wave function $\psi_t=\psi_{GS}(\vec{r},x)(1+bz+crz)$ for an electric field along the z-axis yields the results for $\alpha_D(x)/\alpha_D(0)$ shown in Fig. (2) for Si:P. The VRM-EMA curve for $E_{1s}=E_{EMA}=constant$ has too small a slope and shows no sign of a minimum. The lower VRM]_A(0) curve with EGS(x), $a_A(x)$ and $a_E(x)$ has almost the correct slope at x=0, but falls too steeply. The calculated curve (x) with $\Delta(x)=\Delta(0)[1+0.01x-0.145x^2+0.042x^3]$ gives an excellent fit to the data (•). For the [110] axis case $\alpha_D(x)/\alpha_D(0)$ is well fit by $\Delta(x)=\Delta(0)[1+0.04x-0.115x^2]$, which differs slightly from the [100] axis results. The [100] axis data for a Si:Sb sample can be fit with $\Delta(x)=\Delta(0)[1-0.0635x-0.050x^2+0.004x^3]$.





The $\psi_{GS}(\vec{r},x)$ in Eq. (3) yields a donor Fermi contact piezohyperfine interaction proportional to $|\psi_{GS}(r=0,x)|^2 \propto \gamma^2(x)(1/a_A(x))^3$ since $\psi_{Ea}(\vec{r}=0,x)=0$. Previous work[2] considered only the VRM with a constant $a_A(0)$ and thereby inferred too large a value of Ξ_u . With a small increase on $a_A(x)$ with x_{100} one can explain the donor piezohyperfine interaction with $\Xi_u=8.6~{\rm eV}$, in agreement with an optical result[9]. In Fig. (3a) $a_A(x)$ and $a_E(x)$ are shown versus x_{100} for the two cases $\Delta(0)$ and $\Delta(x)$, the latter for the results above yielding good agreement for $\alpha_D(x)/\alpha_D(0)$. $a_E(x)$ shows a significant increase which decreases slightly at large x for the $\Delta(x)$ case. However, $a_A(x)$ gets



Fig. 3 Bohr radii $a_A(x)$ and $a_F(x)$ and energy $E_{GS}(x)$ vs. x for Si:P

slightly smaller for the $\Delta(0)$ case and slightly larger for the $\Delta(x)$ case. The latter result is in qualitative agreement with the Bohr radius (dashed line) required to explain the donor piezohyperfine interaction. Figure (3b) shows the ground state energy $E_{\rm GS}(x)$ for the two cases $\Delta(0)$ and $\Delta(x)$. Contrary to the Wilson-Feher results[2] $E_{\rm GS}(x)$ for the $\Delta(x)$ case decreases in magnitude in agreement with the increase in $\alpha_{\rm D}(x)/\alpha_{\rm D}(0)$ for $x_{100} > x_{100}^{\rm min}$. In summary the donor $\alpha_{\rm D}(x)/\alpha_{\rm D}(0)$ and piezohyperfine data agree qualitatively when self-consistent changes in $a_{\rm A}(x)$, $a_{\rm E}(x)$, $\Delta(x)$ and $E_{\rm GS}(x)$ are considered.

Another interesting aspect of the results is the surprisingly small N_D -dependence of $\alpha_D(x)/\alpha_D(0)$ from $6\times 10^{16}/\mathrm{cm^3}$, where isolated donors dominate, to $1.9\times 10^{16}/\mathrm{cm^3}$ where clusters are expected to dominate in their contribution to $\varepsilon(N_D)-\varepsilon_h.$ In the low temperature limit only x_{100}^{\min} seems to change with increasing $N_D.$

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